

# Product Range



## Characteristic comparison between the 1200V IGBT<sup>3</sup> generation E3 and T3

### Optimised 1200V IGBT<sup>3</sup> - Chip

➡ IGBT<sup>3</sup> - T3 for low power and medium power modules

- \*  $V_{CEsat}$  reduced by 100mV @  $T_{vj} = 125^{\circ}C$
- \* reduction in turn-off losses of approx. 15%
- \* module name with T3: F...R12...**T3**



power electronics in motion  
**eupec**



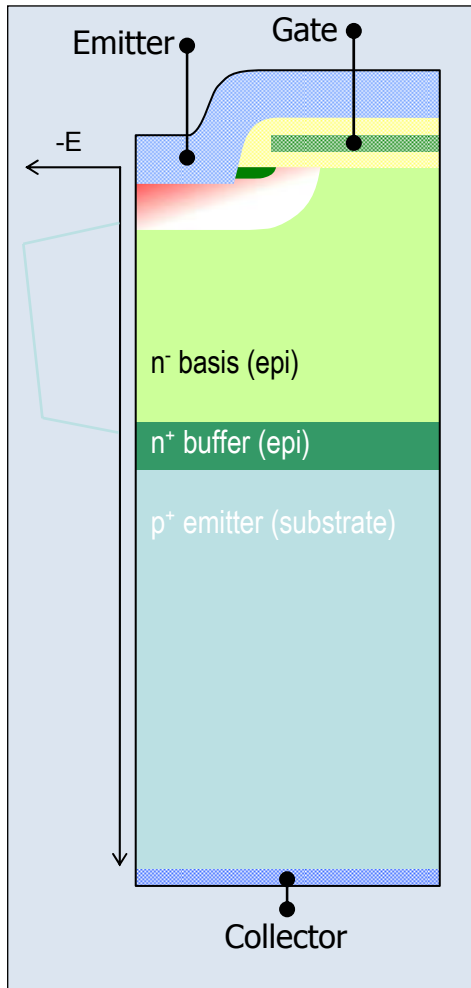
IGBT<sup>3</sup> and EmCon Chip manufacturing in Villach (Austria)

**A long time best manufacturing experience  
and best technologies experience in Power electronic.**

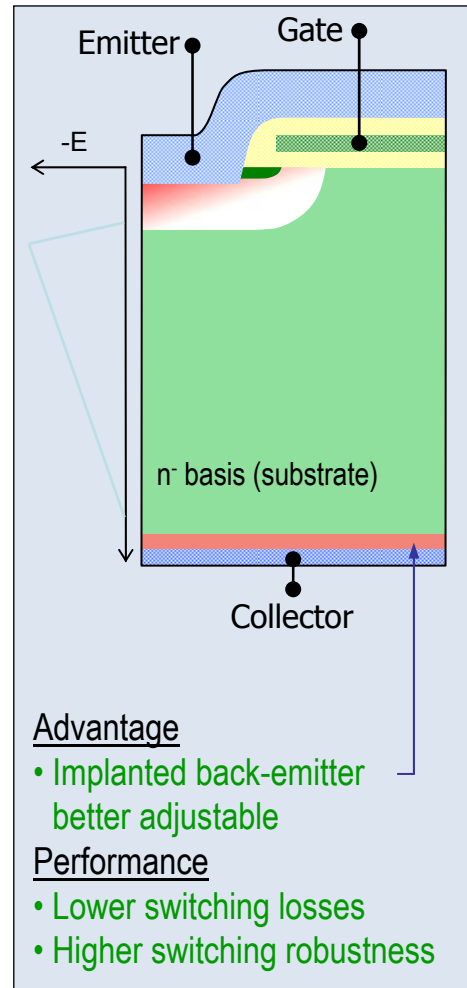
**Certificate by QS-9000**

# PT-, NPT-, Field Stop Technology

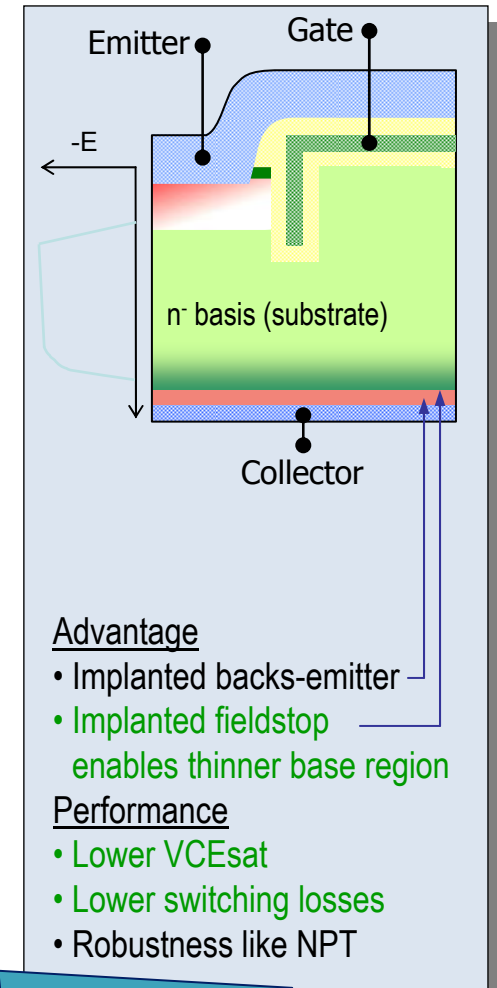
## Pnuch Through



## Non Pnuch Through



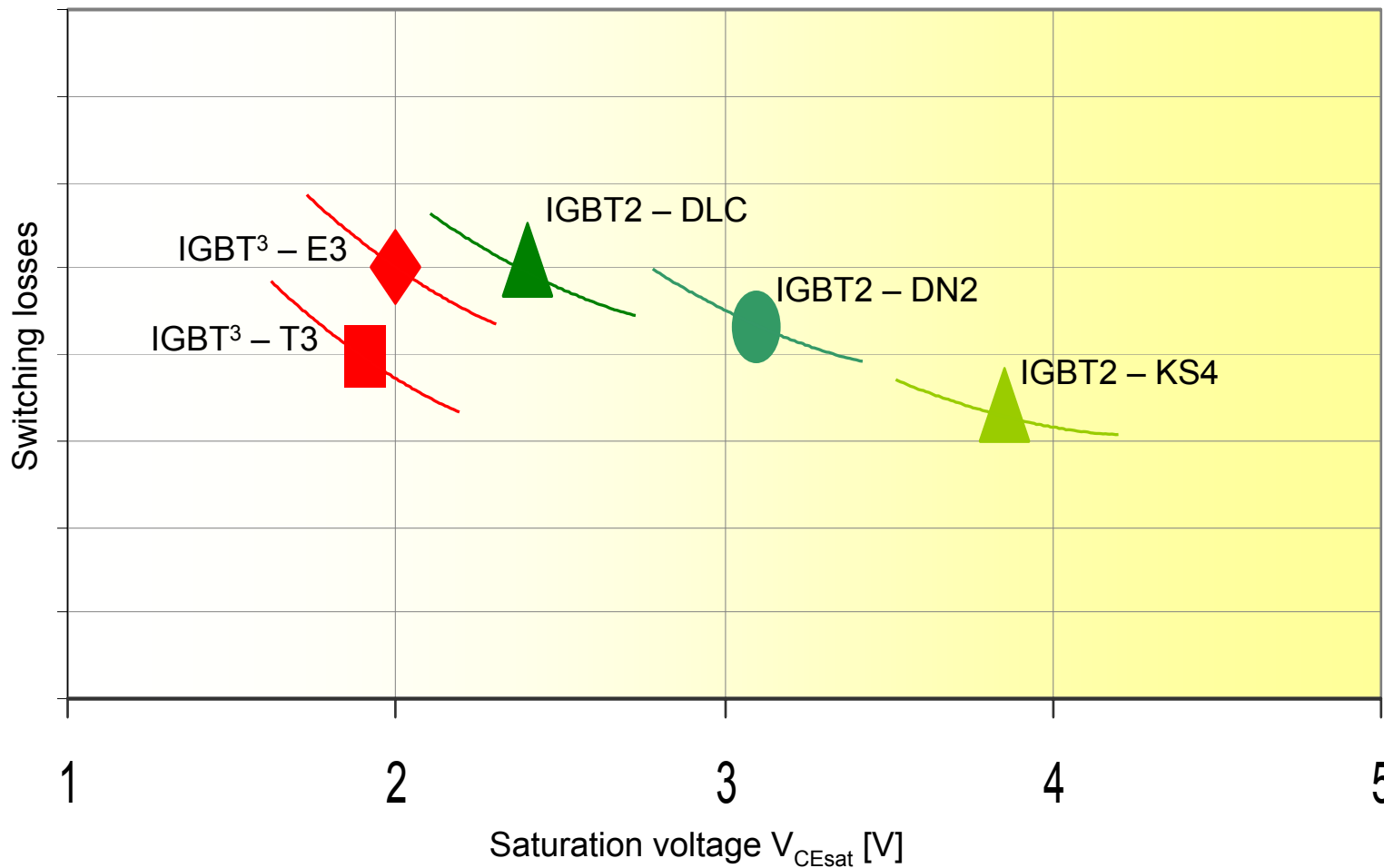
## Trench + Field-Stop



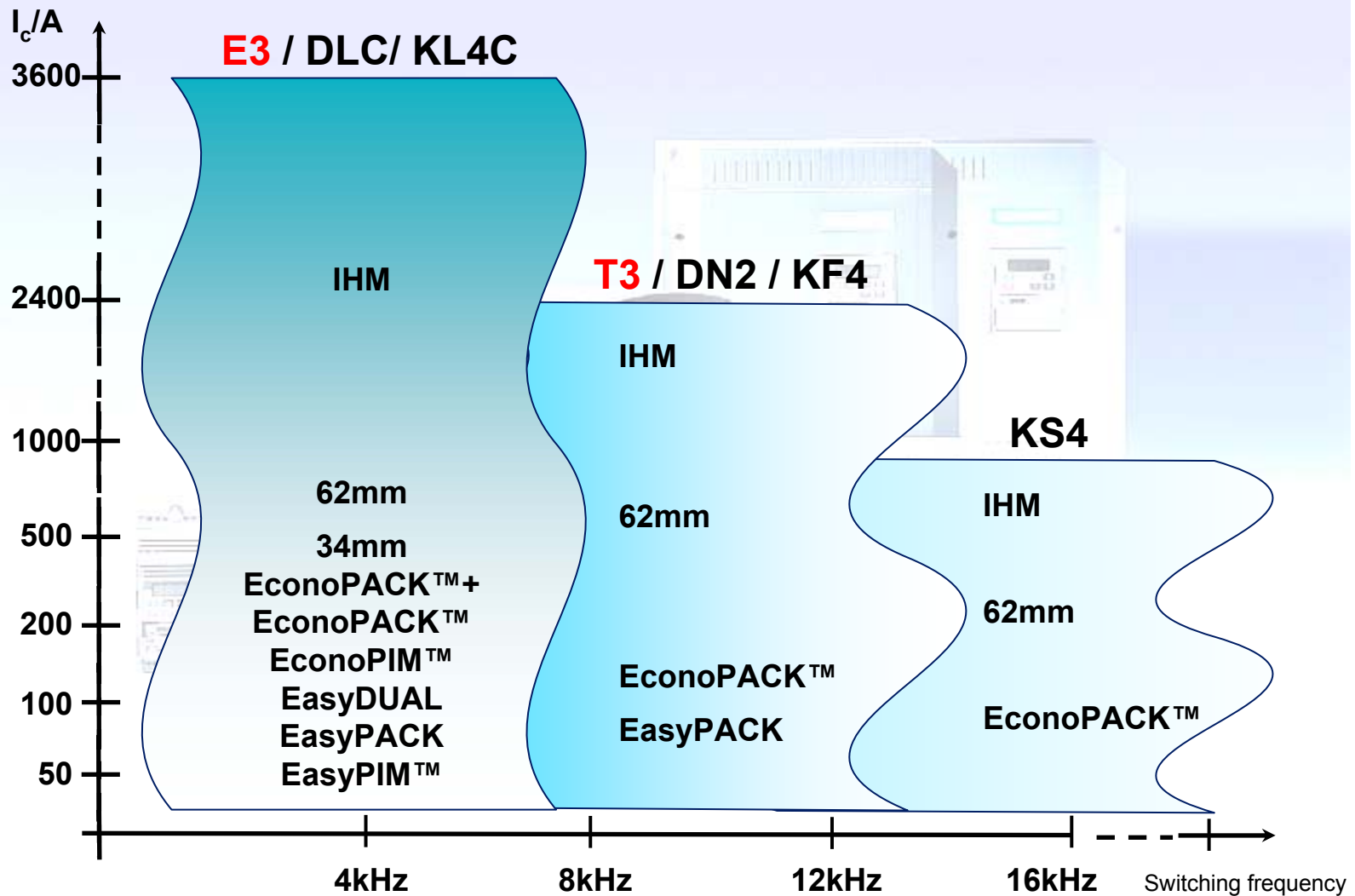
Development Improvements

# 1200V IGBT improvements off

$V_{CEsat}$  vs.  $E_{sw}$  @125°C



# Typical Applications of 1200V Modules



# 62mm – 1200V IGBT / Diode Technology

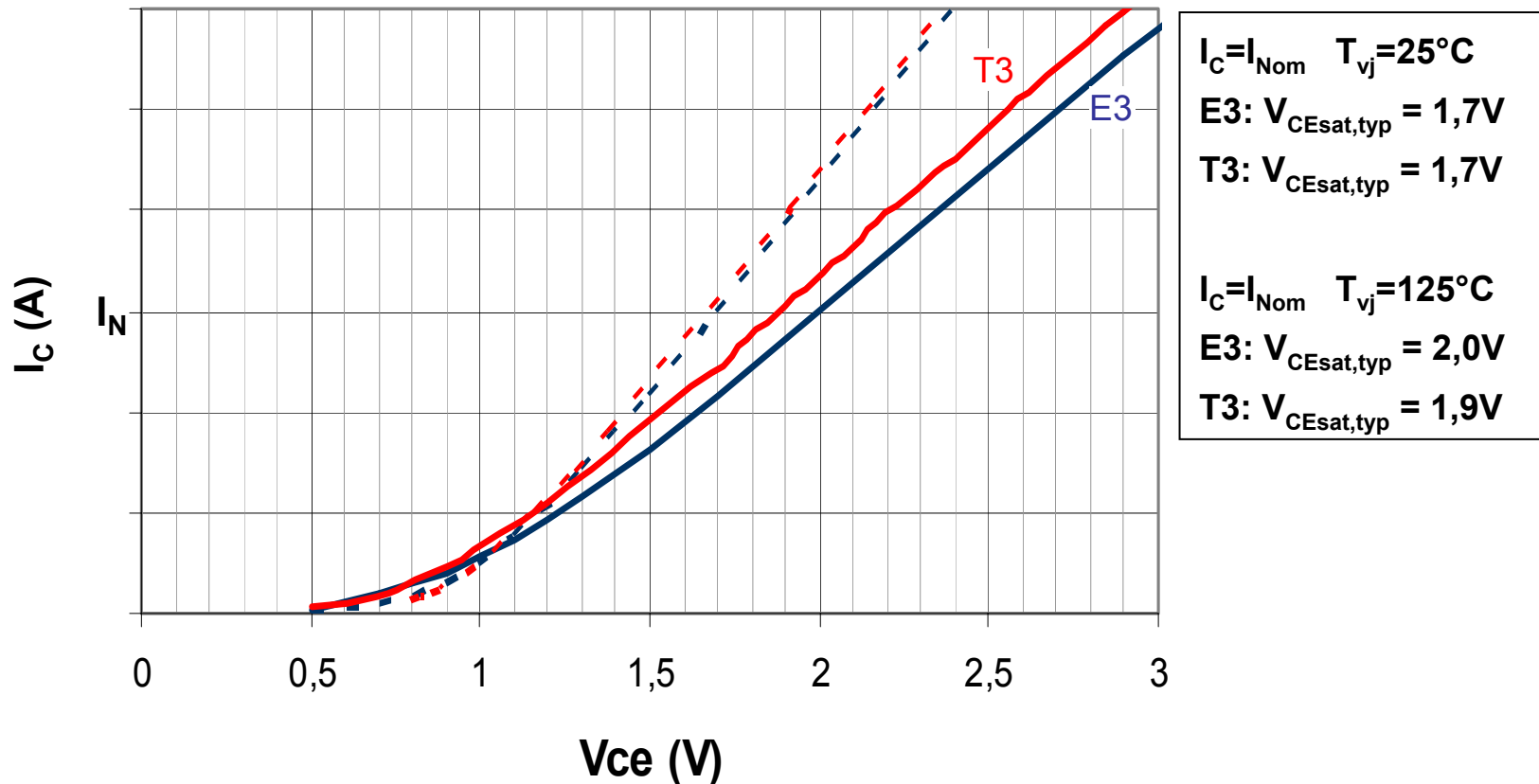
		Standard 2Gen. <b>DN2 / KF4</b>	Low Loss 2Gen. <b>DLC / KL4C</b>	Short Tail 2Gen. <b>KS4 FAST</b>	IGBT <sup>3</sup> <b>E3</b>	Fast IGBT <sup>3</sup> <b>T3</b> <i>New</i>
<b>Technology</b>		NPT optimised : switching - losses	NPT optimised : saturation - voltage	NPT optimised : high switching - frequency	Trench with fieldstop	Trench with fieldstop optimised : high switching - frequency
<b>IGBT</b>	<b>25°C</b>	2,5	2,1	3,2	1,7	1,7
	<b>V<sub>cesat</sub>(V) 125°C</b>	3,1	2,4	3,85	2,0	1,9
<b>Diode</b>		EmConFast / CAL	EmCon	EmConFast / CAL	EmConHE / EmConFast	EmConHE
<b>Diode</b>	<b>25°C</b>	2,0 / 2,3	1,8	2,0 / 2,3	1,65 / 2,0	1,65
	<b>V<sub>f</sub> (V) 125°C</b>	1,7 / 1,8	1,7	1,7 / 1,8	1,65 / 1,7	1,65
<b>Switching - frequency</b>		4 kHz - 15 kHz	1 kHz - 8 kHz	> 15 kHz	1 kHz-8 kHz	1 kHz-15kHz
					Please find additional information in the valid application note AN2003-03 - Switching behavior and optimal driving of IGBT modules	

# Comparison 1200V IGBT<sup>3</sup> chip E3 vs. T3 static parameters (typical)

Output characteristic (typical)

$$I_C = f(V_{CE})$$

$$V_{GE} = 15V$$



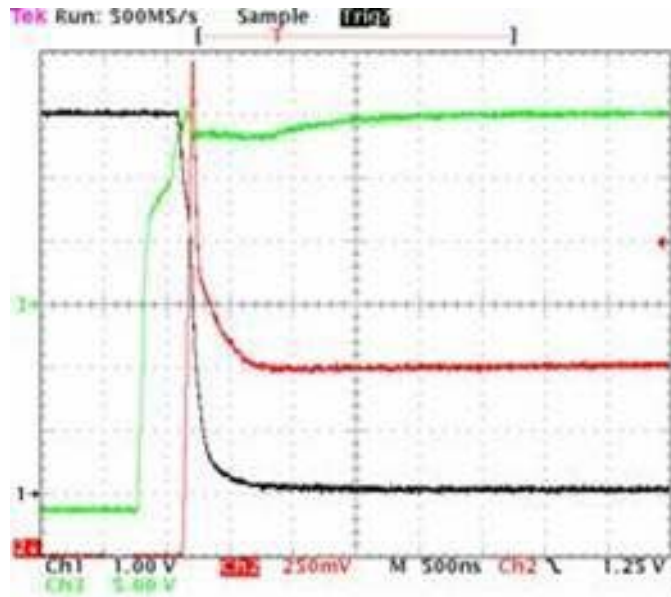
Typical values.



# Comparison 1200V IGBT<sup>3</sup> chip E3 – T3

## Turn-on switching behavior (typical)

### FS75R12KE3



C1 Max  
6.08 V

C2 Max  
1.960 V

C3 Max  
15.4 V

$$V_{CE} = 600V$$

$$I_C = 75A$$

$$T_{vj} = 125^{\circ}C$$

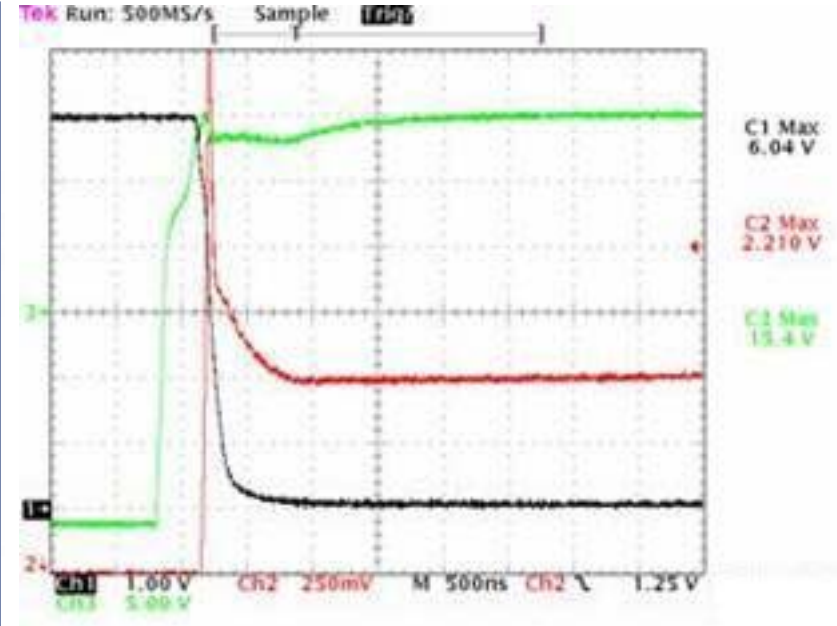
$$R_G = R_{GNom}$$

$$E_{on} = 7,2 \text{ mJ}$$

$$di/dt = 2,4 \text{ kA}/\mu s$$

$$dv/dt = -2,8 \text{ kV}/\mu s$$

### FS75R12KT3



C1 Max  
6.04 V

C2 Max  
2.210 V

C3 Max  
15.4 V

$$V_{CE} = 600V$$

$$I_C = 75A$$

$$T_{vj} = 125^{\circ}C$$

$$R_G = R_{GNom}$$

$$E_{on} = 7 \text{ mJ}$$

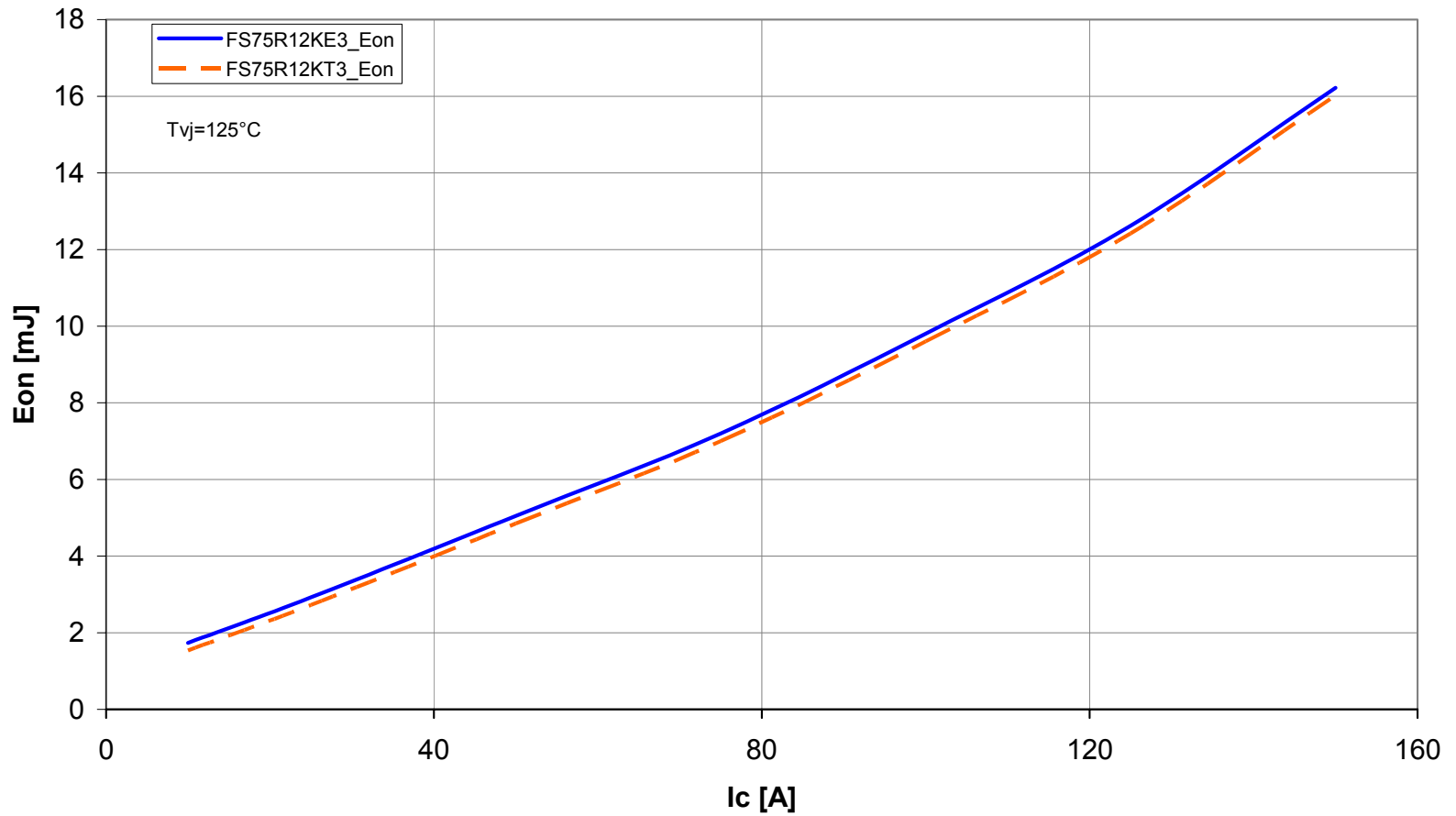
$$di/dt = 3,7 \text{ kA}/\mu s$$

$$dv/dt = -2,9 \text{ kV}/\mu s$$

All measured values are typical.

# Comparison 1200V IGBT<sup>3</sup> chip E3 – T3

## Turn on switching losses (typical)



Typical values.

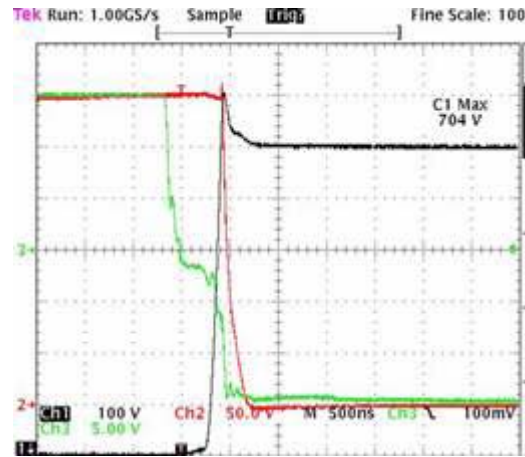
# Comparison 1200V IGBT<sup>3</sup> chip E3 – T3

## Turn-off switching behavior (typical)

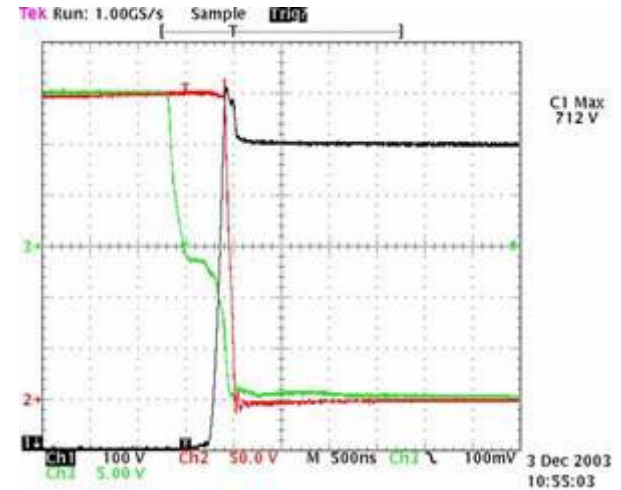
R<sub>g</sub>=R<sub>gnom</sub>  
V<sub>ce</sub>=600V  
I<sub>c</sub>=300A  
L<sub>s</sub>=30nH

T<sub>vj</sub>=25°C

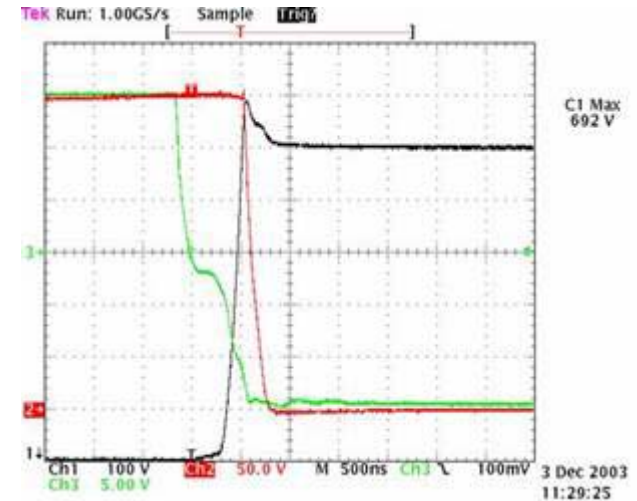
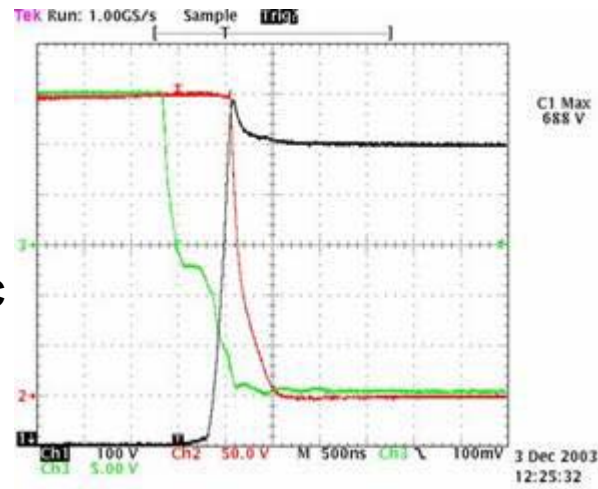
**FF300R12KE3**



**FF300R12KT3**



T<sub>vj</sub>=125°C



All measured values are typical.

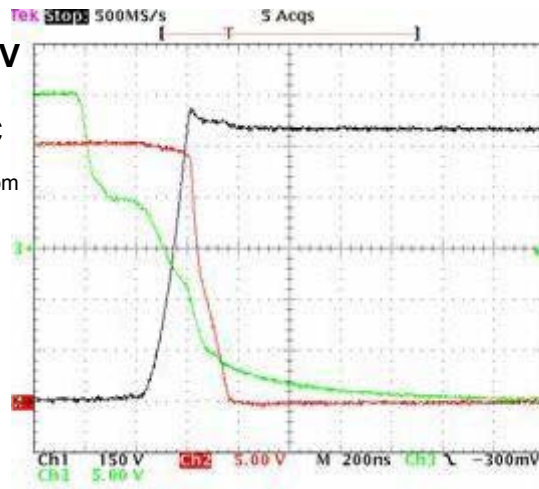
# Comparison 1200V IGBT<sup>3</sup> chip E3 – T3

## Turn-off switching behavior (typical)

### FS25R12KE3G

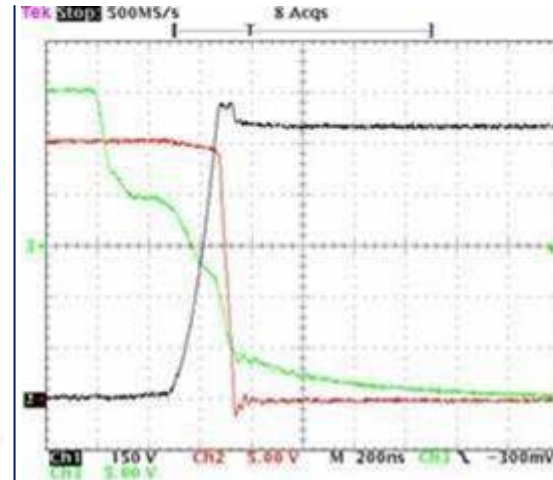
### FS25R12KT3

$V_{CE} = 800V$   
 $I_C = 25A$   
 $T_{vj} = 25^{\circ}C$   
 $R_G = R_{GNom}$



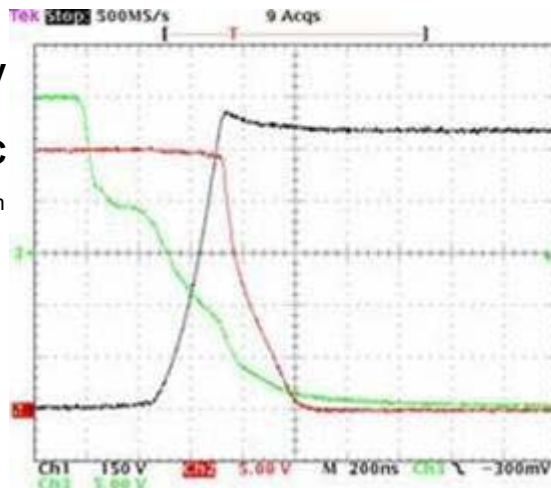
C1 Max  
864 V  
C2 Max  
25.6 V

$V_{CE} = 800V$   
 $I_C = 25A$   
 $T_{vj} = 25^{\circ}C$   
 $R_G = R_{GNom}$



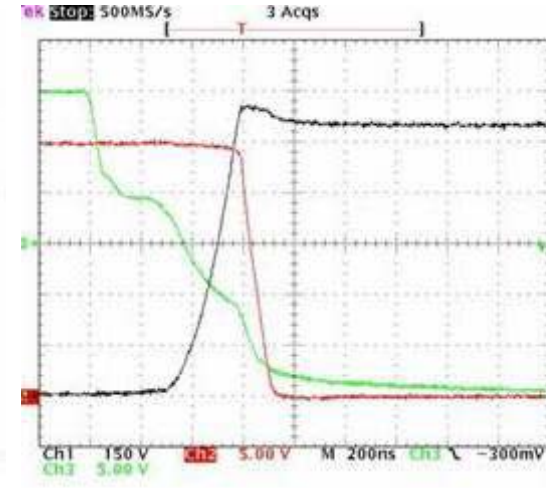
C1 Max  
870 V  
C2 Max  
25.4 V

$V_{CE} = 800V$   
 $I_C = 25A$   
 $T_{vj} = 125^{\circ}C$   
 $R_G = R_{GNom}$



C1 Max  
858 V  
C2 Max  
25.2 V

$V_{CE} = 800V$   
 $I_C = 25A$   
 $T_{vj} = 125^{\circ}C$   
 $R_G = R_{GNom}$



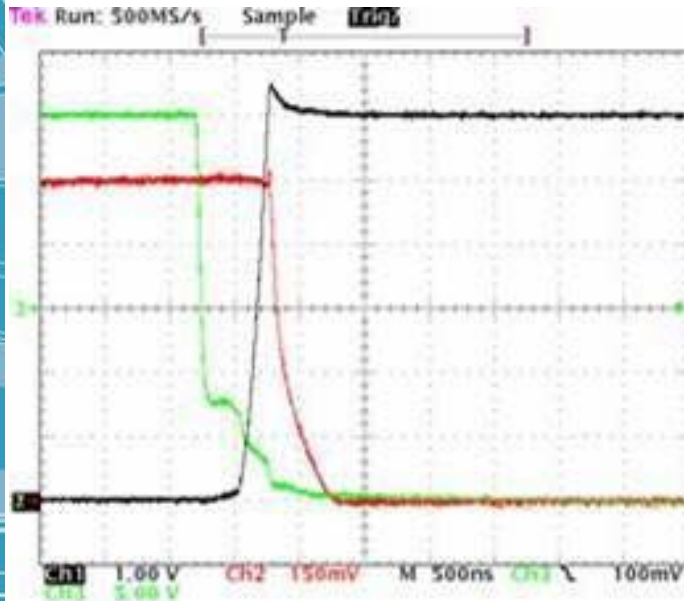
C1 Max  
858 V  
C2 Max  
25.2 V

All measured values are typical.

# Comparison 1200V IGBT<sup>3</sup> chip E3 – T3

## Turn-off switching behavior (typical)

### FS75R12KE3



C1 Max  
6.52 V

C2 Max  
77.4mV

C3 Max  
15.4 V

$$V_{CE} = 600V$$

$$I_C = 75A$$

$$T_{vj} = 125^{\circ}C$$

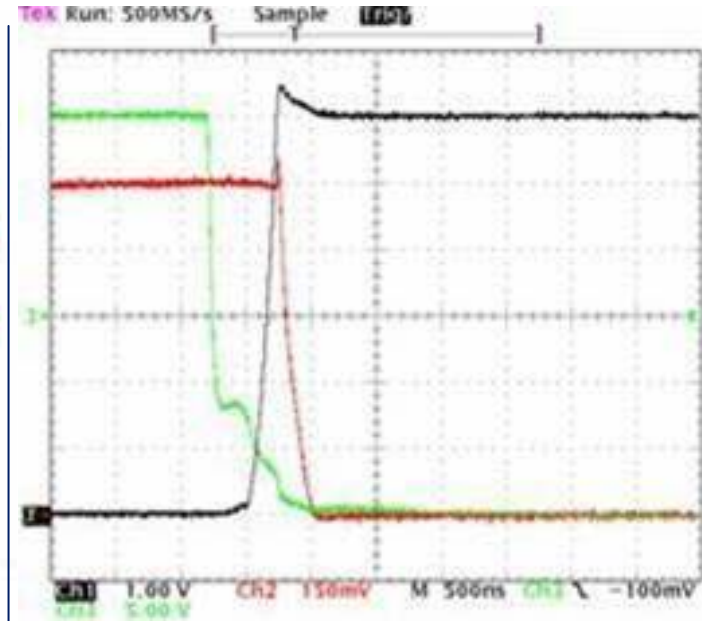
$$R_G = R_{GNom}$$

$$E_{off} = 9,5 \text{ mJ}$$

$$di/dt = -0,39 \text{ kA}/\mu\text{s}$$

$$dv/dt = 3,05 \text{ kV}/\mu\text{s}$$

### FS75R12KT3



C1 Max  
6.48 V

C2 Max  
81.0mV

C3 Max  
15.4 V

$$V_{CE} = 600V$$

$$I_C = 75A$$

$$T_{vj} = 125^{\circ}C$$

$$R_G = R_{GNom}$$

$$E_{off} = 8,1 \text{ mJ}$$

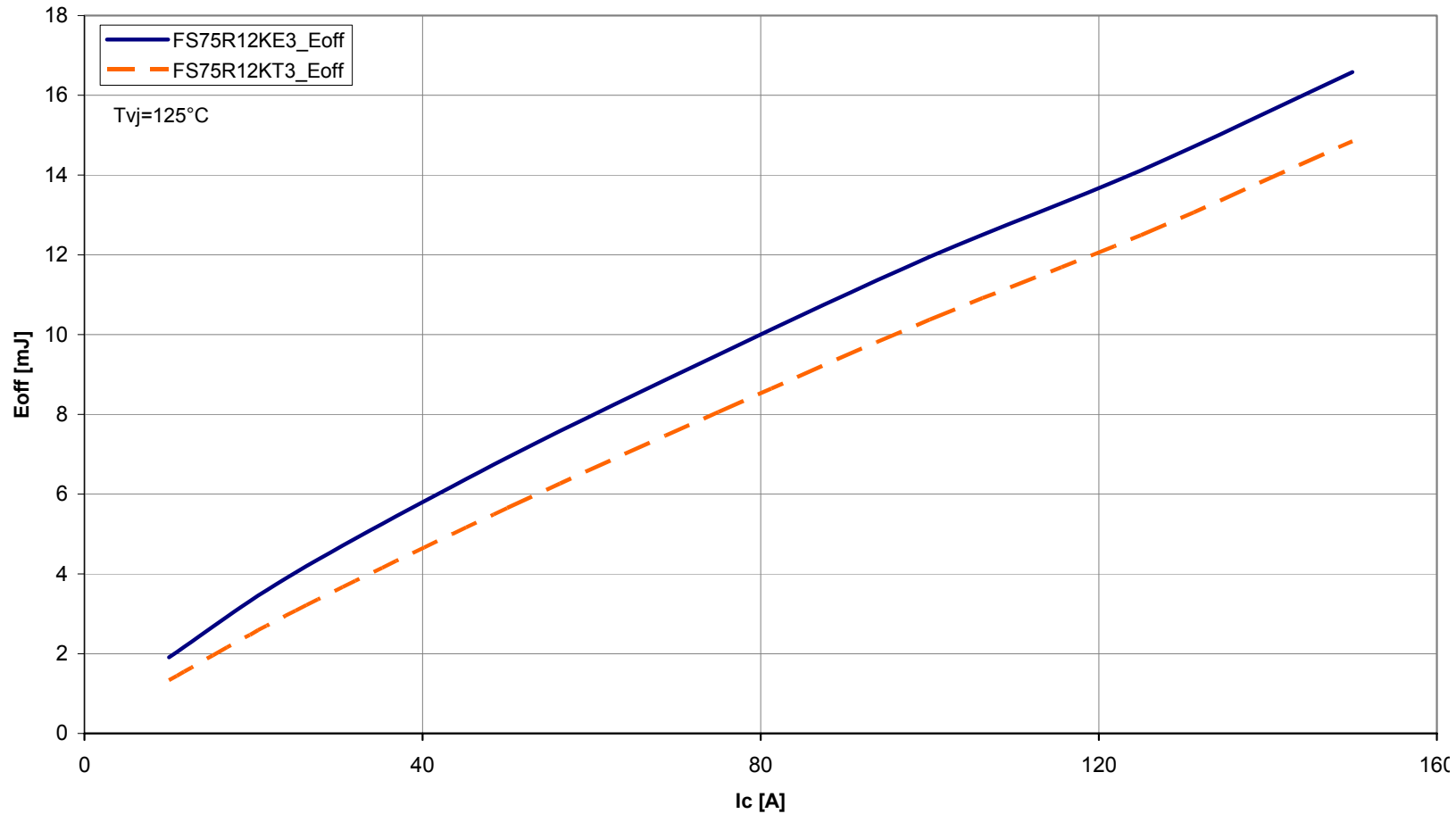
$$di/dt = -0,45 \text{ kA}/\mu\text{s}$$

$$dv/dt = 3,2 \text{ kV}/\mu\text{s}$$

All measured values are typical.

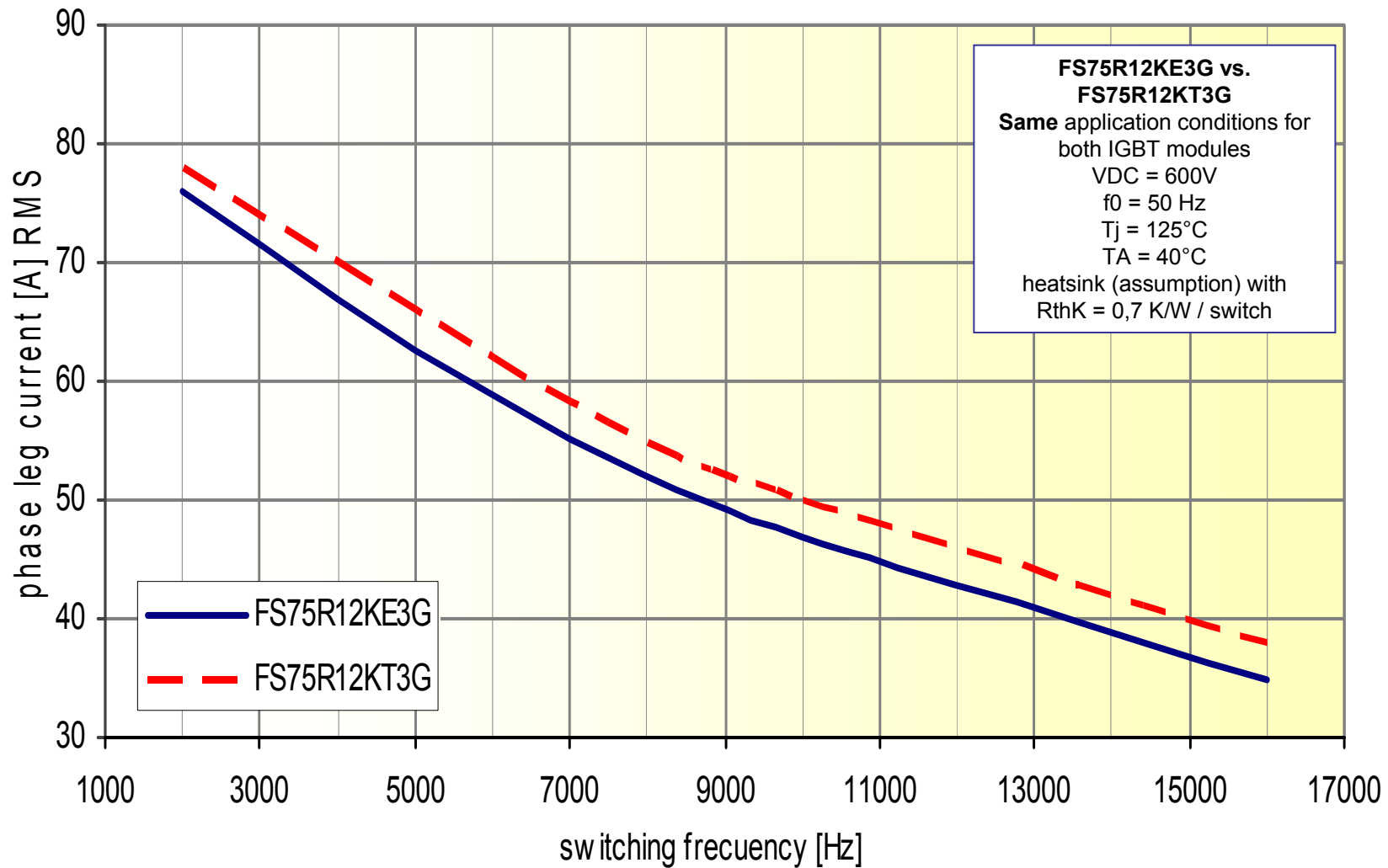
# Comparison 1200V IGBT<sup>3</sup> chip E3 – T3

## Turn off switching losses (typical)



Typical values.

# Comparison 1200V IGBT<sup>3</sup> chip E3 – T3



Approximated calculation by IPOSIM

# Comparison 1200V IGBT<sup>3</sup> chip E3 – T3

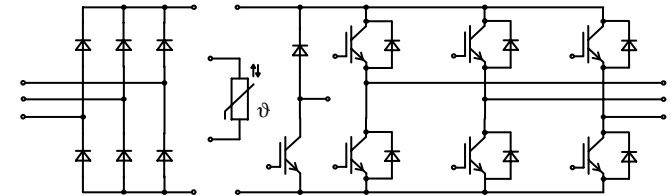
## Summary

- $V_{CEsat}$  at  $T_{vj} = 125^{\circ}\text{C}$  improved by 5% (100mV) at nominal current
- $E_{off}$  improved by 15 % at nominal conditions
- total performance improved up to 10% ( $f_{sw} \leq 15 \text{ kHz}$ )
- Short circuit ruggedness at  $t_p \leq 10 \mu\text{s}$
- Switching behaviour
  - higher di/dt and reduced softness versus E3
  - optimised inverter construction required (low stray inductance)



# Product Range of IGBT<sup>3</sup> – T3



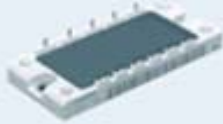


$I_n$	FAST IGBT <sup>3</sup>	TYPICAL PACKAGE
10A	FP10R12YT3	
15A	FP15R12YT3	
10A		
15A	FP15R12KT3	
25A	FP25R12KT3	
35A		
40A	FP40R12KT3	
35A		
40A	FP40R12KT3G	
50A	FP50R12KT3	
75A	FP75R12KT3	

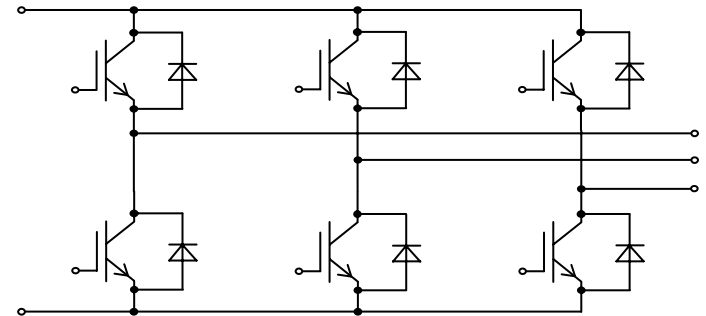


**Power Intergrated Modules  
PIM with IGBT3 – T3  
available in**

- **EasyPIM™**
- **EconoPIM™**

# Product Range of IGBT<sup>3</sup> – T3


$I_n$	FAST IGBT <sup>3</sup>	TYPICAL PACKAGE
10A	FS10R12YT3	
15A	FS15R12YT3	
25A	FS25R12YT3	
35A	FS35R12YT3	
50A		
10A		
15A		
25A	FS25R12KT3	
35A	FS35R12KT3	
50A	FS50R12KT3	
75A	FS75R12KT3	
50A		
75A	FS75R12KT3G	
100A	FS100R12KT3	
150A	FS150R12KT3	



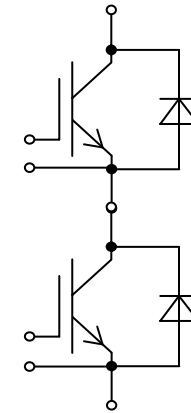
**SIXPACK Modules with IGBT3 – T3 available in**

- **EasyPACK**
- **EconoPACK™**

# Product Range of IGBT<sup>3</sup> – T3

$I_c$ A	IGBT <sup>3</sup> T3	
150	FF 150 R12KT3G	
200	FF 200 R12KT3	
300	FF 300 R12KT3	
400	FF400 R12KT3	

*New*  
*New*  
*New*  
*New*



**Half bridge Modules with  
IGBT3 – T3 available in**

- **62mm C-series**